

The registration fee is to be paid by way of Net banking or UPI payment. The online payment proof should be sent along with the acceptance letter to [icet2023srvec@gmail.com](mailto:icet2023srvec@gmail.com) on or before last date of registration

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#### FOR CONTACT

Convenor, ICET - 23  
Sembodai Rukmani Varatharajan Engineering  
College, Sembodai - 614809, Vedaraniyam Taluk,  
Nagapattinam-Dst, Tamilnadu, India

Mail id: [icet2023srvec@gmail.com](mailto:icet2023srvec@gmail.com)  
Contact No: +91 9789567530  
Website: [www.srvgroups.in/engg](http://www.srvgroups.in/engg)

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## INTERNATIONAL CONFERENCE ON ENGINEERING AND TECHNOLOGY

ICET-2023

27th October

Organised by

**Sembodai Rukmani Varatharajan  
Engineering College**

(Approved by AICTE, New Delhi and Affiliated to Anna University, Chennai)  
Sembodai-614809, Vedaraniyam Taluk, Nagapattinam - Dt,  
Tamilnadu, India



## ABOUT SRVEC

SRVEC was founded by Philanthropist Rtn. Dr. R. Varatharajan, M.com, M.Ed., D.Lit., in 2009. It marks the fulfillment of his long-cherished personal ambition. A Specialty of the College is that it is situated in a peaceful location. It has ample accommodation, spacious classrooms, well-equipped state-of-the-art Laboratories, well-stocked Libraries, and a dedicated band of highly qualified and competent staff. The aim of the Management is to mold the Institution into a School of Excellence and Advanced Learning. With so much to offer, it is only natural that students of SRVEC get a unique opportunity to carve a niche for themselves in their chosen field of study that enables them to become well-rounded and discerning citizens, fully qualified for their chosen professions in the workplace. The Institution has DELNET facilities in our library, Communicative English Training Cell, and associations for all the departments. The college offers 5 undergraduate engineering programs and 4 postgraduate programs.

## ABOUT CONFERENCE

INTERNATIONAL CONFERENCE ON ENGINEERING AND TECHNOLOGY- ICET-2023 is organized by Sembodai Rukmani Varatharajan Engineering College, Sembodai, Nagapattinam, Tamilnadu, India on 27th October 2023. Keeping in pace with the recent advances made in the field of nanotechnology this international conference will be focusing on the current status and recent developments in the fields of Nano, Mechanical, Bio, CSE, Civil, Electrical, and Electronic by covering a wide range of topics but not confined to the following.

INTERNATIONAL CONFERENCE ON ENGINEERING AND TECHNOLOGY aims to bring together scientists in various disciplines, cherish the concepts, interact with eminent personalities, share their views and ideas, and gain knowledge in the field of various aspects. The conference provides a forum to discuss the various technological advantages in diverse fields such as energy harvesting, information technology, aerospace, biotechnology, telecommunications, structural engineering, agriculture, automobiles, and the environment.

## WHO SHOULD ATTEND (ICET-23)?

Individuals involved in Engineering and Technology, whether directly or indirectly, can greatly benefit from enrolling themselves. This includes students, scholars, educators, researchers, industry professionals, and policymakers who can find exclusive opportunities to make significant contributions to the field. Access to a larger global network of Engineering and Technology is also available through networking sessions and avenues that facilitate career growth.

## CALL FOR PAPERS

ICET-2023 accepts full-length original research papers and unpublished research works associated to the conference's mentioned topics. Research Scholars, UG and PG students, engineering professionals from academic institutions, industries, and R&D organisations are invited to submit papers. Full papers (maximum of six pages) should be submitted in IEEE format, with a soft copy in document format forwarded to icet2023srvec@gmail.com. The article should not have been published or be under review in any journals, magazines, or conference proceedings. All submitted articles will be subjected to peer review, and the author will be notified of the results.

## PEER REVIEW PROCESS

The submitted articles will go through peer review based on the review committee's standards for originality, research content, topic of interest, conference relevance, and readability. The editor decides whether to accept, change, or reject a submission based on the reviewer's suggestions or remarks.

## PUBLICATIONS

All the accepted papers will be published in the Proceedings of ICET-2023. On the demand of authors, research papers will be forwarded to SCOPUS indexed and Web of Science Journals.

## Mechanical & Civil Engineering

Mechanical Science and Technology Advances, Instrumentation and Control, Automation and Mechatronics, System Dynamics and Simulation, Heat and Mass Transfer, Applied Mechanics, Automotive Engineering, Machinery and Machine Design, Computational Mechanics, Mechanical Design, Dynamics and Vibration, CAD/CAM, Manufacturing System and Simulation, Manufacturing Robots, Product Design, Additive Manufacturing, Sustainable Infrastructure Development, Smart Cities, Construction Project Management, Geotechnical Engineering, Environmental Engineering, Structural Engineering, Transportation Engineering.

## EEE & ECE

Automation, Electrical Engineering, Electromagnetics, Electronics, Mechatronics, Microwave Circuits, Mobile Computing, Photonics, Power Electronics, Linear Integrated Circuits, Analog Electronics, Electronic Switching Circuits, Digital Electronics and Logic Design, Analog Communication Systems, Network Analysis and Synthesis, VLSI and MEMS Technology, Communication Theory, Electronic Measurement and Instrumentation, Data Structure and Algorithm, Reliability and Quality Management, Embedded System, Antenna and Wave Propagation, Digital Signal Processing.

## CSE & IT

Artificial Intelligence, AI & critical systems, Quantum Computing, Accelerated Graphics Port, Cloud computing, Machine Learning, Cloud Print for Android, Computer multitasking, Edge Computing, Cyber Security, The world of Blockchain, Internet of Things (IoT) Transparent Display: Concept Vs Reality Dynamic random-access memory (DRAM) Google cloud computing Evolution of Computers Intelligent Apps Google Glass: Future of Computers! Programmable read-only memory (PROM) Quantum computer vs Chemical computer Remote computer access Super Computers Wearable computer Virtual Reality

## Nano & Bio Technology

Nanotechnology and Nanomaterials, Nanomaterials and Nanoparticles, Advanced Nanomaterials and Nano Technology, 3D Printing and Graphene Technology, Material Science and Nanomaterials, Advanced Bio-Materials, Bio-sensors & Bio-devices, Nanoscience And Technology, Nanocatalysis and Application in Chemical Industry, Nano photonics, Composite Coatings, Surface Interfaces, Biofabrication, Biomaterials, Biomechanics, Bioprocess Engineering, Biosafety and Biosecurity, Biosensors and Biomolecular Electronics, Industrial Biotechnology, Metabolic Engineering, Genetic Engineering, Agriculture Biotechnology

## IMPORTANT DATES

Commencement of Abstract Submission	10.10.2023	Full Paper Submission	20.10.2023
Last date of Abstract Submission	15.10.2023	Last date for Registration	22.10.2023
Notification of Acceptance	17.10.2023	Release of Conference Scheduled	25.10.2023

## REGISTRATION FEE

DELEGATES	INDIAN IN INR	FOREIGN IN USD
Students - UG, PG	500	30
Academic, Research Scholar	750	40
Industrial/Corporate Delegates/Others	1000	50

REGISTRATION  
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